

Renesas Synergy<sup>™</sup> Platform

# Out-of-Box (OoB) Demonstration (Blinky) Application for S1/S3/S5 Target Board Kits

# Introduction

This application note provides the implementation details of the Out-of-Box (OoB) Demonstration (Blinky) application that comes pre-programmed on the Synergy Target Board Kits. This application note also provides step-by-step instructions to:

- Import and build the application project using the Synergy Software Package and e<sup>2</sup> studio Integrated Solutions Development Environment (ISDE) or IAR Embedded Workbench<sup>®</sup> for Renesas Synergy<sup>™</sup> (IAR EW for Synergy).
- 2. Download and execute the application on Synergy Target Board Kits.
- 3. Recreate, generate, and build the application with any modifications that you intend to make in the application provided.

# **Required Resources**

To build and run the application, you need the following:

	Hardware	Software and Development Tools
System	<ul> <li>Host PC</li> <li>At least 8 GB of RAM</li> <li>At least 2 GB of free hard disk space</li> <li>One USB 2.0 (or later) port</li> </ul>	<ul> <li>Operating system</li> <li>Windows<sup>®</sup> 7 (or later)</li> </ul>
	One of the following Target Board Kits TB-S3A6, TB-S5D5, TB-S3A3	e <sup>2</sup> studio ISDE v5.4.0.023 or later
	TD-00A0, TD-00D0, TD-00A0	<ul> <li>IAR EW for Synergy v7.71.3 or later</li> <li>Synergy Software Package (SSP) v1.3.0 or later</li> <li>Synergy Standalone Configurator (SSC) v5.4.0.023 or later</li> </ul>
Embedded	TB-S3A1	<ul> <li>e<sup>2</sup> studio ISDE v6.2 or later</li> <li>IAR EW for Synergy v8.2 or later</li> <li>Synergy Software Package (SSP) v1.4.0 or later</li> <li>Synergy Standalone Configurator (SSC) v6_2_0_R20180102 or later</li> </ul>
	TB-S1JA, TB-S5D3	<ul> <li>e<sup>2</sup> studio ISDE v6.2.1 or later</li> <li>IAR EW for Synergy v8.23.1 or later</li> <li>Synergy Software Package (SSP) v1.5.0 or later</li> <li>Synergy Standalone Configurator (SSC) v6_2_1 _R20180629 or later</li> </ul>

Estimated time required is 30 minutes (assuming all the necessary hardware is available, software is installed and ready to use).



#### **Prerequisites and Assumptions**

**Software and Tool readiness:** It is assumed that the Synergy Software Package, J-Link drivers, and development tools are installed on the Windows<sup>®</sup> PC. The software and tools are bundled and can be downloaded using one of the two platform installers:

A. **e<sup>2</sup> studio Platform Installer** installs Synergy Software Package and e<sup>2</sup> studio for Synergy IDE with IAR complier and J-Link USB drivers.

Download from <u>www.renesas.com/synergy/e2studio</u>.

B. IAR Platform Installer installs Synergy Software Package and IAR Embedded Workbench<sup>®</sup> for Renesas Synergy<sup>™</sup> IDE with IAR complier and J-Link USB drivers. Download from <u>www.renesas.com/synergy/ewsynergy</u>.

#### Synergy Standalone Configurator (SSC) (Optional)

SSC can be used with IAR Embedded Workbench<sup>®</sup> for Renesas Synergy<sup>™</sup> IDE and can be downloaded from <u>www.renesas.com/synergy/ssc</u>.

**Tool experience:** It is assumed that the user has prior experience working with embedded development environments such as the e<sup>2</sup> studio Integrated Solutions Development Environment (ISDE).

**Subject knowledge:** It is assumed that the user has basic knowledge about the Synergy Software Package and principles of capacitive touch operation.



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# 1. Application Project Overview

This application project is typically the very first application that you are suggested to work with if you are new to the Renesas Synergy<sup>™</sup> Platform. By running this application project, you become familiar with Synergy Software Package, Synergy MCUs, and the associated e<sup>2</sup> studio ISDE or IAR Embedded Workbench<sup>®</sup> for Renesas Synergy<sup>™</sup> development toolchain.

#### **1.1 Application Software Architecture**

Figure 1 shows the software components of the Blinky application. Here, the Blinky thread toggles the LED by calling the HAL driver.

Application	Blinky Thread
ThreadX®	Application
RTOS	Shared Interface
	HAL IO Port
	BSP
	Synergy MCU

Figure 1. Blinky Application Software Architecture

# 2. Powering up the Board

Power up the Target Board by connecting it to the USB port on the PC using the USB Type-A to USB Micro-B cable. Connect the Micro USB end of the cable to connector J11 (DEBUG USB located in the DEBUG area) on the Target Board. Connect the other end of the cable to the USB port of a host PC. LED2 (PWR) on the Target Board lights up solid green indicating that the Target Board is powered on.

Note: The Target Board uses SEGGER J-Link<sup>®</sup> On-board (OB) as the debug interface. Make sure that the J-Link drivers are installed on your computer by checking for them in the Windows Device Manager. If J-Link drivers are not installed on the PC, LED2 (DEBUG) blinks orange. If J-Link drivers are installed on the PC, LED2 (DEBUG) blinks orange with a very small duty cycle that is barely noticeable.

# 3. Importing, Building, and Downloading the Application Project

Refer to the *SSP Import Guide* (r11an0023eu0121-synergy-ssp-import-guide.pdf) for instructions on importing the bundled application project into e<sup>2</sup> studio ISDE or IAR EW, to build and run the project. The SSP Import Guide is included in the zipped folder along with this application note.

Note: You need to select the **OoB\_Demo\_TBxxx Debug** option from the GDB Hardware Debugging configuration window based on the kit for debugging.

# 4. Running the Application Project

On running the Out-of-Box (OoB) Demonstration (Blinky) application project, the LED 1 flashes red at an interval of 0.5 seconds using the RTOS times.



#### 5. Recreating, Generating, and Building the Application Project

You can make modifications to the source code of the provided application project if needed. The procedures for recreating, generating, and building the project using the e<sup>2</sup> studio ISDE or Synergy SSC for IAR EW are explained in the following sections.

#### 5.1 Recreating the Application Project

- 1. In e<sup>2</sup> studio ISDE, click **File** > **New** > **Synergy C/C++ Project**.
- 2. For IAR EW for Synergy, click **Renesas Synergy** > **New Synergy Project**. Select the name as described in the figure that follows and select the license file and SSC version.
- 3. Choose Renesas Synergy C Executable Project and click Next (see Figure 2).



Figure 2. Choose "Renesas Synergy C Executable Project"

- 4. Assign a name to use for this tutorial, for example, **Blinky**.
- 5. Identify the license file if the license window is empty. You can locate the license file in your ISDE base directory at ISDE\internal\projectgen\arm\Licenses\SSP\_License\_Example\_EvalLicense\_<rev>.xml.



For TB-S1JA Boards using  $e^2$  studio, in order to build the project, you need to install the IAR compiler. You can install this as a plugin as referenced by the document, "Installing IAR Compiler into  $e^2$  studio," available at <u>www.renesas.com</u>. Follow the instructions and select the IAR Toolchain for ARM –(8.x), as shown in the following graphic.

Project         Project name         BLINKY         Use default location         Location:       C:\work\Target_Boards\SSP_1_5_0\workspace\BLINK         Browse         Choose file system:       default	Toolchains GCC ARM Embedded IAR Toolchain for ARM - (8.x) IAR Toolchain for ARM - (legacy,
icense License file: C:\Renesas\Synergy\e2studio_v6.2.1_ssp_v1.5.0-rc1\internal\projectgen\arm License Details: CUSTOMER INFORMATION: Company: Renesas Electronics America Inc. UserName: Renesas Synergy Evaluation User Email: noreply@renesas.com	Change license file
LICENSE INFORMATION: Issued: 31/05/2018	>

Figure 3. e<sup>2</sup> studio IAR Compiler Selection Window



6. The Project Configuration window shows your selection. Click Next.

		Toolchains
Project name Blinky		GCC ARM Embedded
Use default location		IAR ARM Toolchain
	workspace_v5_2_1_010_MIG\Blinky Browse	
License		
License file:	Change license file	
C:\Renesas\e2_studio_v5_2_1_010\inte	ernal\projectgen\arm\Licenses\SSP_License_Examp	
License Details:		
CUSTOMER INFORMATION:	A	
Company: Renesas Electronics Americ		
UserName: Renesas Synergy Evaluation	on User	
	n User	
UserName: Renesas Synergy Evaluatio Email: noreply@renesas.com LICENSE INFORMATION:	n User	
UserName: Renesas Synergy Evaluatio Email: noreply@renesas.com	n User	
UserName: Renesas Synergy Evaluatio Email: noreply@renesas.com LICENSE INFORMATION:	n User	

Figure 4. e<sup>2</sup> studio ISDE Project Configuration Window (part 1)



7. Select the SSP version and the name of your board from the **Device Selection** drop-down list. Click **Next**.

For the TB-S3A6, select **S3A6 TB** as shown in the following graphic. For any others, choose the applicable Target Board.

8. Select **Blinky with ThreadX** project template and click **Finish**.

Device Selecti	on	e2 studio - Project Configuration (Synergy C Project)
SSP version:	1.3.0 ~	Select the type of project you wish to create.
Board:	S3A6 TB	Project Template Selection
Device:	R7FS3A6783A01CFP	BSP Base Board Support Package for the chosen Synergy family [Renesas.Synergy.1.3.0.pack]
		Blinky Blinky project. [Renesas.Synergy.1.3.0.pack]
		Blinky with ThreadX     Threaded version of Blinky project.     [Renesas.Synergy.1.3.0.pack]

Figure 5. e<sup>2</sup> studio ISDE Project Configuration Window (part 2)

# 5.2 Generating Project Content

Click the Generate Project Content button.

The project files are generated with the configuration options you selected. Your new project is now created, configured, and ready to build.



Figure 6. Generate Project Content Button

# 5.3 Building the Project

Build the application project by clicking the hammer <sup>11</sup> icon as shown in the following graphic.



Figure 7. Build Button

# 5.4 Running the Application

Run the project and verify the functionality as per the modifications performed in the source code of the provided application project.



#### 6. Next Steps

1. Learn more about the Target Board Kit.

Visit the Target Board Kit webpage (www.renesas.com/synergy/tb-sXXX) to learn more about the kit and download documentation, schematics, design files, and so forth. For example, the TB-S5D5 Target Board Kit webpage is at <u>www.renesas.com/synergy/tb-s5d5</u>.

#### 2. Explore existing application projects for the Target Board Kit.

Renesas provides several application projects to demonstrate different capabilities of the S1/S3/S5 MCU Series. These application projects can also serve as a good starting point for you to develop your custom application. Application projects available for the Target Board Kit are listed on the Target Board Kit webpage (www.renesas.com/synergy/tb-sXXX).

For example, TB-S5D5 Target Board Kit webpage is at <u>www.renesas.com/synergy/tb-s5d5</u>.

#### 3. Learn more about the Synergy Platform.

Visit the following URLs to learn about the following elements of the Synergy Platform and download different components:

- Synergy Software: <u>www.renesas.com/synergy/software</u>
- Synergy Hardware: <u>www.renesas.com/synergy/hardware</u>
- Synergy Solutions Gallery: <u>www.renesas.com/synergy/solutionsgallery</u>

#### 7. Limitations and Assumptions

None



# Website and Support

Visit the following vanity URLs to learn about key elements of the Synergy Platform, download components and related documentation, and get support.

Synergy Software		www.renesas.com/synergy/software
	Synergy Software Package	www.renesas.com/synergy/ssp
	Software add-ons	www.renesas.com/synergy/addons
	Software glossary	www.renesas.com/synergy/softwareglossary
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Synergy Hardware		www.renesas.com/synergy/hardware
,	Microcontrollers	www.renesas.com/synergy/mcus
	MCU glossary	www.renesas.com/synergy/mcuglossary
	Parametric search	www.renesas.com/synergy/parametric
	Kits	www.renesas.com/synergy/kits
Synergy Solutions Gallery		www.renesas.com/synergy/solutionsgallery
	Partner projects	www.renesas.com/synergy/partnerprojects
	Application projects	www.renesas.com/synergy/applicationprojects
Self-se		www.renesas.com/synergy/applicationprojects
Self-se	Application projects ervice support resources: Documentation	
Self-se	ervice support resources: Documentation	www.renesas.com/synergy/docs
Self-se	ervice support resources:	www.renesas.com/synergy/docs www.renesas.com/synergy/knowledgebase
Self-se	ervice support resources: Documentation Knowledgebase	www.renesas.com/synergy/docs
Self-se	ervice support resources: Documentation Knowledgebase Forums	www.renesas.com/synergy/docs www.renesas.com/synergy/knowledgebase www.renesas.com/synergy/forum
Self-se	ervice support resources: Documentation Knowledgebase Forums Training	www.renesas.com/synergy/docs www.renesas.com/synergy/knowledgebase www.renesas.com/synergy/forum www.renesas.com/synergy/training



# **Revision History**

		Description	
Rev.	Date	Page	Summary
1.00	Aug.29.17	-	Initial release
1.01	Oct.13.17	-	Updated the version information, SW architecture diagram, and added module guide collateral links.
1.02	Oct.26.17	-	Updated to SSP v1.3.2
1.03	Feb.27.18	-	Added support for TB-S3A1
1.04	Sep.17.18	-	Added Support for TB-S1JA, TB-S5D3
1.05	Feb.08.19	8	Updated Website and Support URLs



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